



E28-2G4M27SX User Manual

SX1280 2.4GHz 500mW SPI High-speed LoRa module

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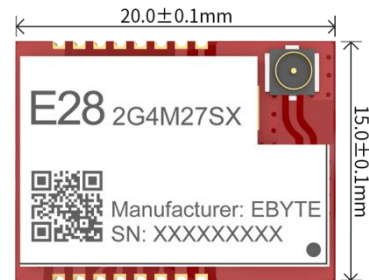
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Chapter 1 Product Overview

1.1 Product Introduction

E28-2G4M27SX is a 2.4GHz RF transceiver module designed and produced by Ebyte Company, with a transmit power of 500mW, SPI interface, and extremely low current consumption in low-power mode; the module is a small-volume SMD type (pin spacing 1.27mm), using 52MHz industrial-grade high-precision low-temperature drift crystal oscillator to ensure its industrial characteristics and its stable performance.



Using Semtech's SX1280 radio frequency chip, this chip contains a variety of physical layers and a variety of modulation methods, such as LoRa, FLRC, GFSK, and is compatible with Bluetooth protocols; special modulation and processing methods make LoRa and FLRC modulation The transmission distance has significant Improvement, built-in power amplifier (PA) and low noise amplifier (LNA) on the basis of the original, so that the maximum transmit power reaches 500mW and the receiving sensitivity is further improved, and the overall communication stability is compared with no power amplifier and low Noise amplifier products have been greatly improved; excellent low-power performance, on-chip DC-DC and Time-of-flight make this chip powerful and can be used in smart homes, security systems, location tracking, wireless ranging, wearable devices, Smart bracelets and health management, etc. SX1280 supports RSSI, users can realize in-depth secondary development according to their needs, and also integrates time of flight, which is suitable for ranging function.

E28-2G4M27SX is a pure RF transceiver module, which needs to be driven by MCU or use a dedicated SPI debugging tool.

1.2 Features and Functions

- Under ideal conditions, the communication distance can reach 8km;
- Built-in PA+LNA, maximum transmit power 500mW;
- Compatible with BLE protocol;
- Support license-free ISM 2.4GHz frequency band;
- Support data transmission rate of 0.595k~2Mbps;
- Support multiple modulation modes (GFSK Mode, FLRC Mode, LoRa Mode) ;
- Support 2.5 ~ 3.6V power supply, more than 3.3V power supply can ensure the best performance;
- Adjustable air rate, up to 1.3Mbps under FLRC modulation;
- Excellent anti-blocking properties;
- Ranging, with Time-of-flight function.

1.3 Application

- Smart home and industrial sensors, etc;

- Security system, positioning system;
- Wireless remote control, drone;
- Wireless game remote;
- Healthcare products;
- Wireless voice, wireless headset;
- Automotive industry applications.

Chapter 2 Technical Parameters

2.1 Limit parameters

Main parameters	Performance		Remark
	Min	Max	
Supply voltage (V)	0	3.6	Exceeding 3.6V will permanently burn the module
Blocking power (dBm)	-	10	The probability of burning at close range is small
Working temperature (°C)	-40	+85	Industrial grade

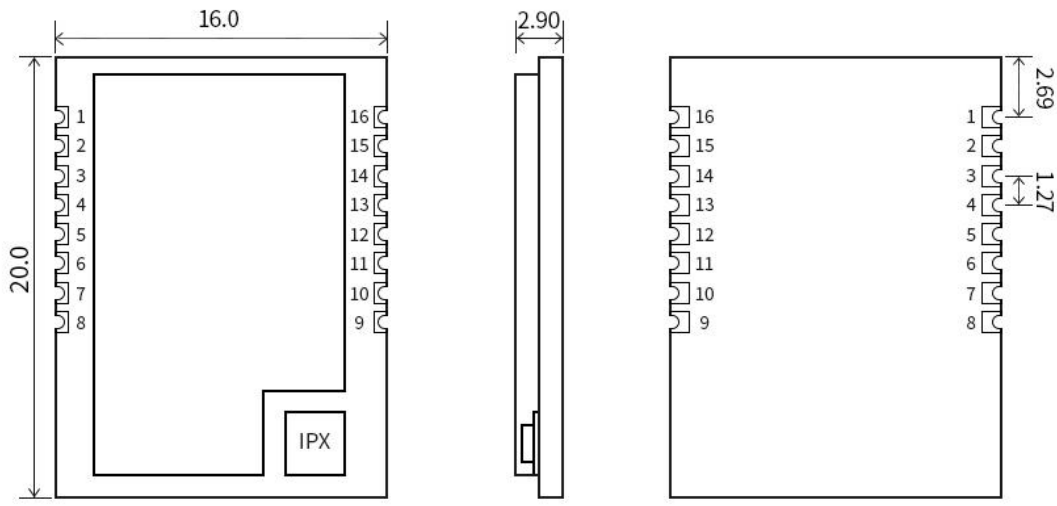
2.2 Working parameters

Main parameters		Performance			Remark
		Min	Typ	Max	
Working voltage (V)		2.5	3.3	3.6	$\geq 3.3V$ can guarantee output power
Communication level (V)			3.3		Risk of burnout with 5V TTL
Working temperature (°C)		-40	-	85	Industrial grade design
Working frequency band (MHz)		2400	2450	2500	Support ISM band
Power consumption	Emission current (mA)		580		Instantaneous power consumption
	Receive current (mA)		14.5		
	Sleep current (μA)		2.0		software shutdown
Maximum transmit power (dBm)		26	26.5	27	See section 4.2 for details
Receive Sensitivity (dBm)		-130	-131	-132	LoRa receiver sensitivity with CR=4/5 and high sensitivity mode enabled 1 SF12, BW=203kHz
Air Rate	LoRa (bps)	0.595k	-	253.9k	User programmable customization
	FLRC (bps)	260k	-	1.3M	User programmable customization
	GFSK (bps)	125k	-	2M	User programmable customization

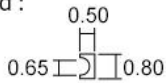
Main parameters	Description	Remark
Reference Distance	8000m	Clear and open, antenna gain 5dBi, antenna height 2.5 meters, air rate 1kbps

FIFO	256Byte	The maximum length of a single transmission
Crystal Frequency	52MHz	$\pm 10\text{ppm}/11\text{pF}$
Modulation	LoRa (recommend)	GFSK, FLRC, LoRa
Packaging Method	SMD	
Interface	1.27mm	
Communication Interface	SPI	0~10Mbps
Dimensions	15*20mm	
Antenna Interface	IPEX/PCB	Equivalent impedance is about 50Ω

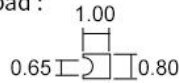
Chapter 3 Mechanical Dimensions and Pin Definition



Top pad :



Bottom pad :



Unit : mm
 pad quantity : 16
 Tolerance value : X.X \pm 0.1mm
 X.XX \pm 0.05mm

Pin Number	Pin item	Pin Orientation	Application
1	VCC		Power supply, range 2.5~3.6V (recommended to add external ceramic filter capacitor)
2	GND		Ground wire, connected to the power reference ground
3	MISO_TX	Output	SPI data output pin; can also be used as UART transmit pin (see SX1280 manual for details)
4	MOSI_RX	Input	SPI data input pin; can also be used as a UART receive pin (see SX1280 manual for details)

5	SCK_RTSN	Input	SPI clock input pin; can also be used as a UART request to transmit pin (see SX1280 manual for details)
6	NSS_CTS	Input	Module chip select pin, used to start an SPI communication; also used for UART clear transmit pin (See SX1280 manual for details)
7	GND		Ground wire, connected to the power reference ground
8	RX_EN	Input	LNA control pin, active high
9	TX_EN	Input	PA control pin, active high
10	GND		Ground wire, connected to the power reference ground
11	NRESET	Input	Chip reset trigger input pin, active low, built-in pull-up resistor 50K
12	BUSY	Output	Used for status indication (see SX1280 manual for details)
13	DIO1	Input/Output	Configurable general-purpose IO ports (see SX1280 manual for details)
14	DIO2	Input/Output	Configurable general-purpose IO ports (see SX1280 manual for details)
15	DIO3	Input/Output	Configurable general-purpose IO ports (see SX1280 manual for details)
16	GND		Ground wire, connected to the power reference ground

Chapter 4 Basic Operations

4.1 Hardware design

- It is recommended to use a DC regulated power supply to supply power to the module, the power supply ripple coefficient should be as small as possible, and the module should be grounded reliably;
- Please pay attention to the correct connection of the positive and negative poles of the power supply, such as reverse connection may cause permanent damage to the module;
- Please check the power supply to ensure that it is between the recommended power supply voltages. If it exceeds the maximum value, the module will be permanently damaged;
- Please check the stability of the power supply, the voltage should not fluctuate greatly and frequently;
- When designing the power supply circuit for the module, it is often recommended to reserve more than 30% of the margin, so that the whole machine can work stably for a long time;
- The module should be kept as far away as possible from the power supply, transformer, high-frequency wiring and other parts with large electromagnetic interference;
- High-frequency digital traces, high-frequency analog traces, and power traces must avoid the underside of the module. If it is absolutely necessary to pass under the module, assuming that the module is soldered on the Top Layer, lay copper on the Top Layer of the contact part of the module. Copper and well grounded), must be close to the digital part of the module and routed on the Bottom Layer;
- Assuming that the module is soldered or placed on the Top Layer, it is also wrong to arbitrarily route wires on the Bottom Layer or other layers, which will affect the stray and receiving sensitivity of the module to varying degrees;
- Assuming that there are devices with large electromagnetic interference around the module, it will also greatly affect the performance of the module. It is recommended to stay away from the module

according to the intensity of the interference. If the situation allows, appropriate isolation and shielding can be done;

- Assuming that there are traces with large electromagnetic interference around the module (high-frequency digital, high-frequency analog, power traces), the performance of the module will also be greatly affected. It is recommended to stay away from the module according to the intensity of the interference. Proper isolation and shielding;
- If the communication line uses 5V level, a 1k-5.1k resistor must be connected in series (not recommended, there is still a risk of damage);
- Try to stay away from some TTL protocols whose physical layer is also 2.4GHz, such as USB3.0;
- The antenna installation structure has a great influence on the performance of the module. Make sure that the antenna is exposed, preferably vertically upward. When the module is installed inside the casing, a high-quality antenna extension cable can be used to extend the antenna to the outside of the casing;
- The antenna must not be installed inside the metal shell, which will greatly reduce the transmission distance.

4.2 Software editing

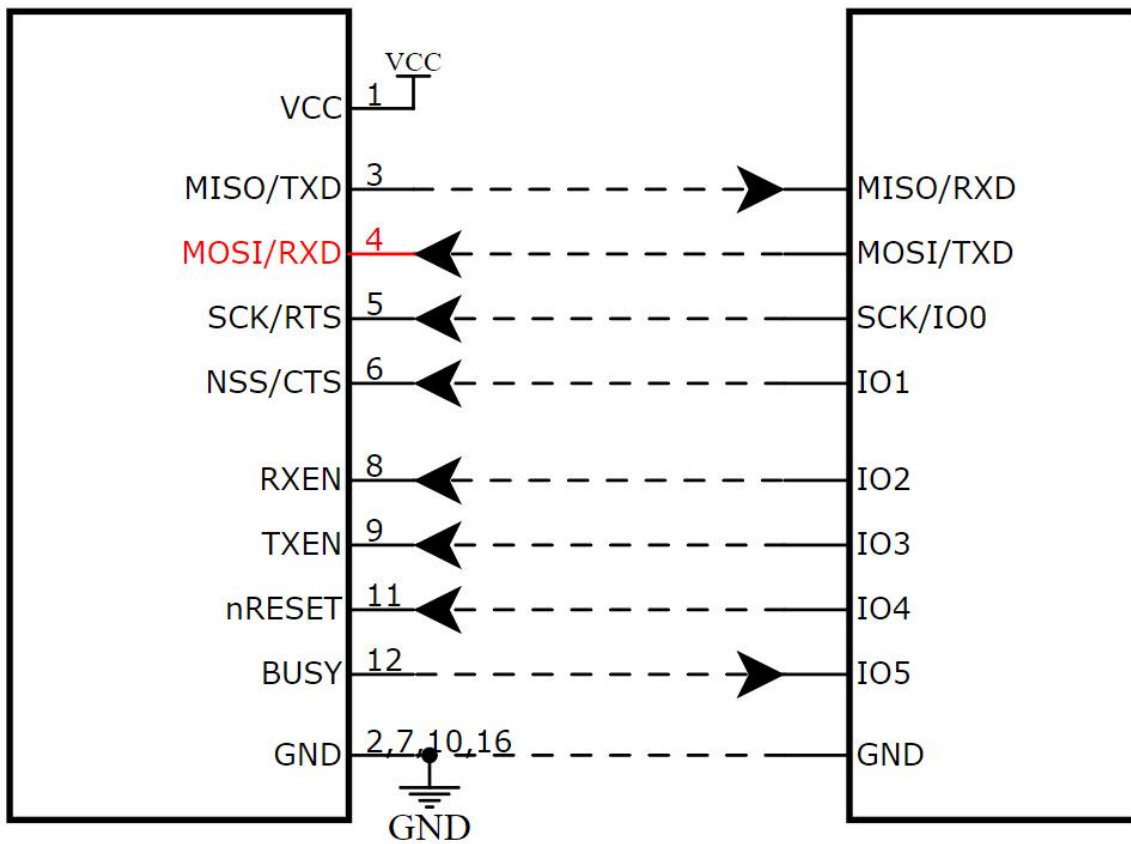
- This module is SX1280+PA+LNA, its driving mode is completely equivalent to SX1280, users can operate according to the SX1280 chip manual;
- GD00 is a general-purpose I/O port, see SX1280 manual;
- GD02 is generally configured as an IRQ-like function, or it can be disconnected. The SPI query method can be used to obtain the interrupt status, but it is recommended to use the external interrupt of the microcontroller for connection;
- After the SX1280 is restored to IDLE mode or configured in sleep mode, it is recommended to re-initialize the power configuration table.
- It is recommended to set the power output parameter of SX1280 to 0dBm. At this time, the module can output power of 27dBm. When the output power of SX1280 is increased, the current will increase, and the power will not increase significantly.

Chapter 5 Basic Applications

5.1 Basic circuit

E28-2G4M27SX

MCU



Chapter 6 FAQ

6.1 Communication range is too short

- When there is a straight-line communication obstacle, the communication distance will be correspondingly attenuated;
- Temperature, humidity, and co-channel interference will increase the communication packet loss rate;
- The ground absorbs and reflects radio waves, and the test effect close to the ground is poor;
- Seawater has a strong ability to absorb radio waves, so the seaside test effect is poor;
- If there is a metal object near the antenna, or is placed in a metal shell, the signal attenuation will be very serious;
- The power register is set incorrectly, and the air rate is set too high (the higher the air rate, the closer the distance);
- The low voltage of the power supply at room temperature is lower than the recommended value, and the lower the voltage, the lower the output power;
- The antenna used is poorly matched with the module or the quality of the antenna itself is faulty.

6.2 Module is easy to damage

- Please check the power supply to ensure that it is between the recommended power supply voltages. If it exceeds the maximum value, the module will be permanently damaged;
- Please check the stability of the power supply, the voltage should not fluctuate greatly and frequently;
- Please ensure anti-static operation during installation and use, and high-frequency components are electrostatically sensitive;
- Please ensure that the humidity during installation and use should not be too high, and some components are humidity-sensitive devices;
- If there is no special requirement, it is not recommended to use it at too high or too low temperature.

6.3 Bit error rate is too high

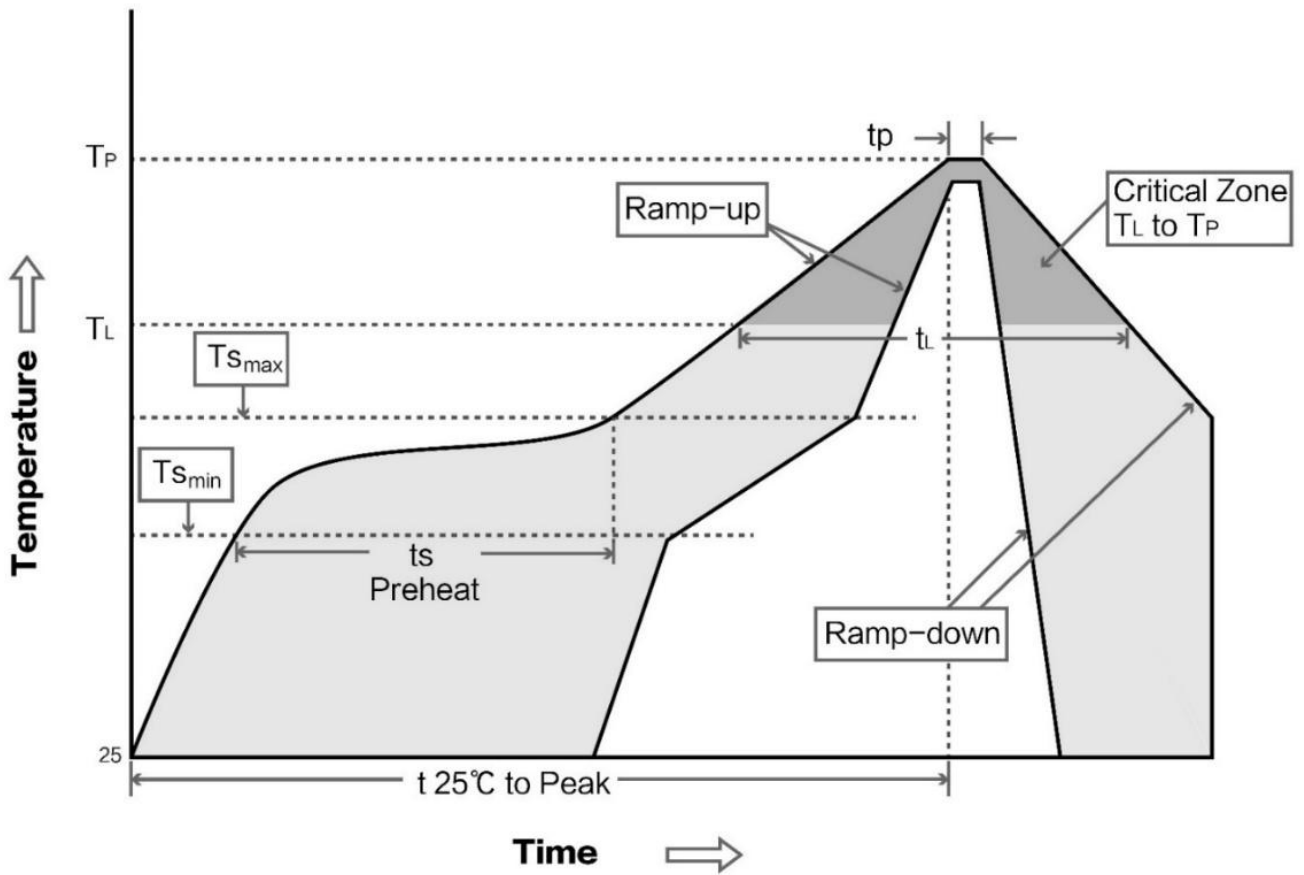
- There is co-frequency signal interference nearby, stay away from the interference source or modify the frequency and channel to avoid interference;
- The clock waveform on the SPI is not standard, check whether there is interference on the SPI line, and the SPI bus line should not be too long;
- If the power supply is not ideal, it may also cause garbled characters. Be sure to ensure the reliability of the power supply;
- Poor quality or too long extension lines and feeder lines will also cause a high bit error rate.

Chapter 7 Welding Operation Guidance

7.1 Reflow temperature

Profile Feature	Curve feature	Sn-Pb Assembly	Pb-Free Assembly
Solder Paste	Solder paste	Sn63/Pb37	Sn96.5/Ag3/Cu0.5
Preheat Temperature min (T _{min})	Minimum preheat temperature	100°C	150°C
Preheat temperature max (T _{max})	Maximum preheat temperature	150°C	200°C
Preheat Time (T _{min} to T _{max}) (ts)	Preheat time	60-120 sec	60-120 sec
Average ramp-up rate(T _{max} to T _p)	Average rate of ascent	3°C/second max	3°C/second max
Liquidous Temperature (TL)	Liquidus temperature	183°C	217°C
Time (t _L) Maintained Above (TL)	Time above liquidus	60-90 sec	30-90 sec
Peak temperature (T _p)	Peak temperature	220-235°C	230-250°C
Average ramp-down rate (T _p to T _{max})	Average rate of descent	6°C/second max	6°C/second max
Time 25°C to peak temperature	Time from 25° C to peak temperature	6 minutes max	8 minutes max

7.2 Reflow soldering curve



Chapter 8 Related Models

Model	IC	Frequency	Power	Distance	Size	Package	Interface
		Hz	dBm	km	mm		
E28-2G4T12S	SX1280	2.4G	12.5	3	17.5*28.7	SMD	TTL
E28-2G4M27S	SX1280	2.4G	27	8	15*26.5	SMD	SPI
E28-2G4M20S	SX1280	2.4G	20	6	15*26.5	SMD	SPI
E28-2G4M12S	SX1280	2.4G	12.5	3	25*14	SMD	SPI

Chapter 9 Antenna Guidelines

9.1 Antenna recommendation

Antennas play an important role in the communication process, and often inferior antennas will have a great

impact on the communication system. Therefore, our company recommends some antennas as antennas with excellent performance and reasonable price for our wireless modules.

Model	Type	Frequency	Gain	Size	Feeder	Interface	Features
		Hz	dBi	mm	cm		
TX2400-NP-5010	FPC	2.4G	2.0	10x50	-	IPEX	Flexible FPC Soft Antenna
TX2400-JZ-3	Rubber	2.4G	2.0	30	-	SMA-J	Ultra-short straight, omnidirectional antenna
TX2400-JZ-5	Rubber	2.4G	2.0	50	-	SMA-J	Ultra-short straight, omnidirectional antenna
TX2400-JW-5	Rubber	2.4G	2.0	50	-	SMA-J	Fixed bent, omnidirectional antenna
TX2400-JK-11	Rubber	2.4G	2.5	110	-	SMA-J	Bendable glue stick, omnidirectional antenna
TX2400-JK-20	Rubber	2.4G	3.0	200	-	SMA-J	Bendable glue stick, omnidirectional antenna
TX2400-XPL-150	Sucker	2.4G	3.5	150	150	SMA-J	Small suction cup antenna, cost-effective

Revise History

Version	Revision Date	Revision Notes	Operator
1.0	2022-10-13	Bug fixes	Yan

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